Final Technical Report

High Surface Area Electrode Research

Supported under Grant #N00014-96-1-1109 Office of the Chief of Naval Research Report for the period 7/10/96-12/31/96

S. Roberson and R. F. Davis
North Carolina State University
Materials Science and Engineering Department
Campus Box 7907
Raleigh, NC 27695

DISTRIBUTION STATEMENT A

Approved for public release;
Distribution Unlimited

December, 1996

19970106 078

REPORT DOCUMENTATION PAGE

Form Approved
OMB No. 0704-0188

Public reporting burden for this collection of information is estimated to average 1 hour per response, including the time for reviewing instructions, searching existing data sources, gathering and maintaining the data needed, and completing and reviewing the collection of information. Send comments regarding this burden estimate or any other aspect of this collection of information, including suggestions for reducing this burden to Washington Headquarters Services, Directorate for Information, Operations and Reports, 1215 Jefferson Davis Highway, Suite 1204, Arlington, VA 22202-4302, and to the Office of Management and Budget Paperwork Reduction Project (0704-0188), Washington, DC 20503.

Davis Highway, Suite 1204, Arlington, VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management and Budget Paperwork Heducation (1996), VA 22202-4302, and to the Office of Management (1996), and the Office of					
1. AGENCY USE ONLY (Leave blank)	2. REPORT DATE	3. REPORT TYPE AND DATES COVERED			
	December, 1996	Final Technical 7/10/96–12/31/96			
4. TITLE AND SUBTITLE			5. FUNDING NUMBERS		
High Surface Area Electrode	Research		96PR06926-00		
			312		
6. AUTHOR(S)			N68892		
Daham E David			N66020		
Robert F. Davis			4B855		
7. PERFORMING ORGANIZATION NAME(S) AND AD	DRESS(ES)		8. PERFORMING ORGANIZATION		
			REPORT NUMBER		
North Carolina State Univers	1ty				
Hillsborough Street Raleigh, NC 27695			N00014-96-1-1109		
raioign, ito 27070					
9. SPONSORING/MONITORING AGENCY NAMES(S)		2217 5660	10. SPONSORING/MONITORING AGENCY REPORT NUMBER		
Sponsoring: ONR, Code 312, 800 Monitoring: Admin. Contracting O	officer, ONR, Regional Officer	e Atlanta			
101 Marietta Tower, Suite 2805	,,				
101 Marietta Street Atlanta, GA 30323-0008					
11. SUPPLEMENTARY NOTES					
12a. DISTRIBUTION/AVAILABILITY STATEMENT			12b. DISTRIBUTION CODE		
Approved for Public Release	· Distribution Unlimited				
rippioved for rubile Release	, Dibaioadon Ciminio				
13. ABSTRACT (Maximum 200 words)		!			

Molybdenum nitride (Mo_xN (x=1 or 2)) films, 15 μ m thick, have been deposited via chemical vapor deposition (CVD) on 50 μ m thick polycrystalline titanium substrates using molybdenum pentachloride ($MoCl_5$) and NH_3 in a cold wall reactor with vertical pancake heaters. The surface morphology of the films was slightly porous but did not contain the large cracks typical of high surface area Mo_xN films prepared by conversion of MoO_3 . Debye-Scherrer calculations indicate that the average particle size of the films was approximately 50 nm. The CVD Mo_xN films had a two-phase structure which appeared to be 60% d-MoN and 40% g- Mo_2N . Energy dispersive X-ray (EDX) data did not reveal the presence of oxygen and chlorine in films deposited above 600°C. Electrode evaluation via AC impedance spectroscopy and cyclic voltammetry indicates that CVD films were capacitive with a voltage stability of 0.9 volts in 6.4 M KOH.

14. SUBJECT TERMS			15. NUMBER OF PAGES	
molybdenum nitride, films, ammonia, surface morpho	9			
chlorine, AC impedance sp	16. PRICE CODE			
17. SECURITY CLASSIFICATION OF REPORT	18. SECURITY CLASSIFICATION OF THIS PAGE	19. SECURITY CLASSIFICATION OF ABSTRACT	20. LIMITATION OF ABSTRACT	
UNCLAS	UNCLAS	UNCLAS	SAR	

Characteristics of Molybdenum Nitride Electrodes Grown Via Chemical Vapor Deposition

Molybdenum nitride (Mo_xN (x=1 or 2)) films, 15 μ m thick, have been deposited via chemical vapor deposition (CVD) on 50 μ m thick polycrystalline titanium substrates using molybdenum pentachloride ($MoCl_5$) and NH_3 in a cold wall reactor with vertical pancake heaters. The surface morphology of the films was slightly porous but did not contain the large cracks typical of high surface area Mo_xN films prepared by conversion of MoO_3 . Debye-Scherrer calculations indicate that the average particle size of the films was approximately 50 nm. The CVD Mo_xN films had a two-phase structure which appeared to be 60% δ -MoN and 40% γ -Mo₂N. Energy dispersive X-ray (EDX) data did not reveal the presence of oxygen and chlorine in films deposited above 600° C. Electrode evaluation via AC impedance spectroscopy and cyclic voltammetry indicates that CVD films were capacitive with a voltage stability of 0.9 volts in 6.4 M KOH.

I. Introduction

The numerous potential applications of conductive high surface area (HSA) materials have prompted research and development into growth of these materials. At present, either HSA graphite powder or ruthenium oxide is generally used as electrode materials for double layer capacitors. However, outgassing of CO in aqueous electrolytes during cyclic charging and discharging limits the use of the former and the latter is uneconomical. Due to these problems, alternative materials are being investigated for use as double layer capacitor electrodes as substitutes for graphite and ruthenium oxide. Alternative candidate materials include the transition metal nitrides M_xN_y (M = Mo, Ti, Ni, V, Cr, or W), which have been shown to have electrical conductivities exceeding 10⁴ ohm-1cm-1 and good resistance to electrochemical decomposition in aqueous electrolytes [1]. More specifically due to its high electrical conductivity and resistance to electrochemical decomposition, molybdenum nitride is a promising candidate electrode material. However, to form high surface area films (> 30 m²/g) of molybdenum nitride, it is advantageous to make use of densification via conversion of MoO₃ to molybdenum nitride [2-5]. Within the molybdenum compound family, the bulk density of MoO₃ ($\rho = 4.69 \text{ g/cm}^3$) is less than MoN ($\rho = 9.05 \text{ g/cm}^3$), and Mo₂N ($\rho = 9.50$ g/cm³). In the conversion of MoO³ to molybdenum nitride, it is evident that the formation Mo²N or MoN would cause a large increase in surface area (i.e., microcracks, pores, and cavitation) given that the densification is not associated with significant shrinkage of the nitride.

Upon trying to convert MoO₃ films to Mo_xN some unreacted oxides will remain [6]. Molybdenum dioxide (MoO₂), which is produced in the incomplete conversion of MoO₃ to Mo_xN , has a + 0.676 volt stability in 4.4 M H₂SO₄ electrolyte. Such oxide contaminated Mo_xN electrodes are limited to a 0.70 volt stability in charging and discharging cycles in 4.4 M H₂SO₄ electrolytes. To reduce the oxide contamination in Mo_xN electrodes, a direct growth process (CVD) using MoCl₅ and NH₃ has been employed.

II. Experimental Procedures

As-received polycrystalline titanium substrates were cut into 1" squares and degreased in pure trichloroethylene, acetone, and methanol in sequential order. The substrates were then etched in a solution of 1.0 M HCl at 90°C for 10 minutes to remove the oxide scale layer. The etched substrates were rinsed and held in pure methanol prior to deposition.

The etched substrates were placed on a molybdenum holder contained in a cold wall, vertical CVD system. The system was evacuated to 10-3 Torr and back-filled with ultra high purity (UHP) N2 to 1000 Torr. This process was repeated seven times to reduce oxygen present in the system to the amount contained in the UHP N2. The UHP N2 was also used as the carrier gas for the MoCl₅, which was contained in a stainless steel metalorganic bubbler. The bubbler was maintained at a constant temperature of 55°C to give a MoCl₅ vapor pressure of 2 Torr. The MoCl₅/N₂ gas delivery line to the deposition region was heated to slightly higher temperatures than the bubbler temperature to reduce condensation of MoCl₅. The unheated NH₃ gas delivery line was isolated from the MoCl₅ delivery line to minimize the formation of NH₄Cl. The formation of NH₄Cl was also minimized by employing an alternating cycle deposition method, in which MoCl₅ was cycled for 0.5 seconds every minute, while NH3 flow was maintained at all times except when the MoCl₅/N₂ was flowing. The MoCl₅/N₂ and NH₃ flow rates during the deposition process were 2.5 1/min and 1.5 1/min respectively, and were controlled by mass flow controllers. The deposition pressure was 100 Torr and was maintained by a throttle valve. The substrates were heated by a resistive SiC-coated graphite heater to the desired Mo_xN deposition temperature, and the deposition cycle was initiated by flowing N₂/MoCl₅ for 0.5 seconds. Termination of the deposition process was accomplished by cessation of the MoCl₅/N₂ flow, while maintaining NH₃ flow for 5 minutes at deposition temperatures.

The electrical, structural, and chemical characteristics of the Mo_xN films were analyzed. Scanning electron microscopy (SEM) was performed using a JEOL 6400FE operating at 5 kv which was equipped with an Oxford Light Element Energy Dispersive X-ray (EDX) Microanalyzer. X-ray diffraction (XRD) data was obtained on a Rigaku X-ray diffraction apparatus operating at 27.5 kv. Electrical properties of the Mo_xN electrodes were evaluated by AC impedance spectroscopy and cyclic voltammetry in 6.4M KOH electrolytes.

III. Results and Discussion

The HSA film electrodes currently used in double layer energy storage devices generally have a macroscopic, highly-cracked microstructure. In the present research, polycrystalline Mo_xN films have been deposited on titanium substrates without the mudcrack macrostructure. As shown in Fig. 1a, the thickness across the textured surface of CVD Mo_xN films varied by 1 μ m on 15 μ m thick films. An SEM micrograph of a Mo_xN electrode prepared by the conversion of MoO_3 is shown for comparison in Fig. 1b. The surface roughness of CVD Mo_xN films is more apparent in 45° rotation SEM micrographs shown in Fig. 2a and Fig. 2b. The surface roughness is believed to be due to a combination of high deposition rates (1 μ m/min) and rapid surface reaction of $MoCl_5$ and NH_3 . With a deposition rate of 1 μ m/min at 600°C, very little surface diffusion occurs and particles remain "frozen" on the surface and react rapidly when exposed to NH_3 . Higher deposition rates would be detrimental to film quality, crystallinity, and adhesion.

The chemical properties of the Mo_xN films were examined using XRD and EDX. X-ray diffraction patterns of the two phase CVD and converted Mo_xN films are shown in Fig. 3a and Fig. 3b, respectively. The CVD films consisted of $\approx 60\%$ δ -MoN and 40% γ -Mo₂N; and converted Mo_xN films consisted of $\approx 60\%$ γ -Mo₂N and 40% δ -MoN. The peak broadening in the XRD patterns was due to nanoparticle formation in the films. Furthermore, the EDX pattern, with the nitrogen peak removed for clarity, of a typical CVD Mo_xN film deposited at 600° C indicates that no residual chlorides or oxides were present. However, at deposition temperatures less than 400° C chlorine was detected. This was due to the difficulty in thermally cracking NH₃ at temperatures below 500° C. As shown in Fig. 4b, the EDX pattern for a typical Mo_xN film prepared by the conversion of MoO_3 shows considerable amounts of oxygen present in the film. The oxygen present in the CVD Mo_xN films approximates the amount of residual oxygen present due to physical absorption of water, air, and hydrocarbons on the surface of the film.

The Debye-Scherrer equation (Eq. 1) was used to calculate the average particle size of the films using the XRD patterns,

$$d=K\lambda/\beta_{hkl}\cos\theta$$
. (1)

Theta (θ) is the Bragg angle; λ is the X-ray wavelength; β_{hkl} is the peak width at half maximum peak height, corrected for instrument broadening; and the correction factor K was taken as unity. To minimize the effects of peak broadening due to residual stresses, particle size calculations were conducted using peak values less than 20°. As shown in Table I, the average particle size of the CVD Mo_xN films was 53 nm, where as the average particle size of converted Mo_xN films was 10 nm.

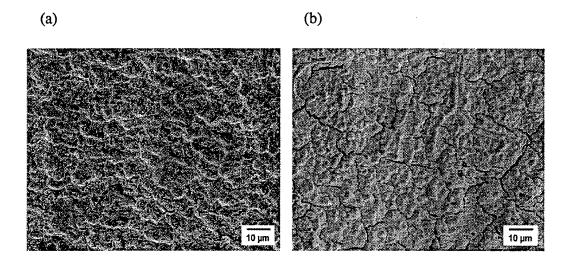


Figure 1. SEM micrographs of (a) CVD Mo_xN film and (b) Mo_xN film converted from MoO₃. The surface of the CVD film does not have the mud crack structure present in (b).

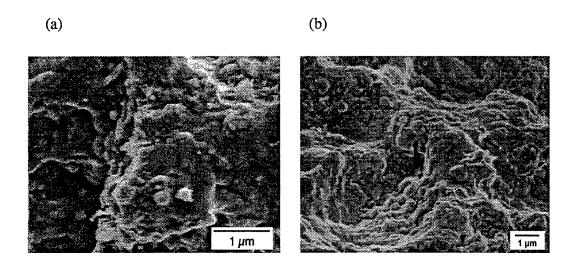


Figure 2. Scanning electron micrographs of CVD Mo_xN films at 45° rotation at (a) magnification of 25,000 and (b) magnification of 10,000. Note the variation in film thickness and the roughness of the surface.

Surface area generation in the conversion of MoO₃ to Mo_xN is the result of the densification of MoO₃ to Mo₂N without the collapse of individual particles. This is called "topotactic" because the crystallographic direction relationships between MoO₃ and Mo₂N are retained [5]. The topotactic reaction creates surface area by the generation of pores in Mo₂N without the collapse of individual crystals. For CVD Mo_xN films, surface area generation takes place by a different process. Molybdenum pentachloride (trigonal, $\rho = 2.98 \text{ g/cm}^3$) reacts rapidly with NH₃ at elevated temperatures to produce Mo_xN ($\rho = 9.05 \text{ g/cm}^3$). This change in density, can create adherence problems. However, the

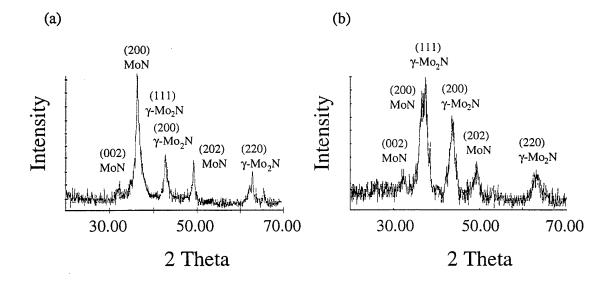


Figure 3. X-ray diffraction patterns of (a) CVD Mo_xN film and (b) Mo_xN film converted from MoO₃. The peak broadening in (a) and (b) is due to nanoparticle formation.

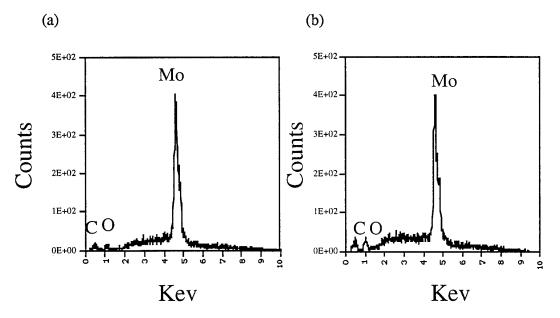


Figure 4. Energy dispersive X-ray patterns of (a) CVD Mo_xN film and (b) Mo_xN film converted from MoO₃. Oxygen contamination was observed in (b).

rapid reaction of MoCl₅ and NH₃ can produce a porous structure without sacrificing film adherence if the deposition reaction is optimized. If the deposition rate is too slow, the complete densification of MoCl₅ will occur which can reduce the surface area. However, if the deposition rate is optimal, then the densification of MoCl₅ to Mo_xN occurs rapidly to

Table I. Calculated Average Particle Sizes of Mo_xN Films Produced by CVD and Conversion Form MoO₃

Process	Phase	θ	Cos θ	β_{hkl}	Particle Size
CVD CVD CVD	MoN MoN Mo ₂ N	15.944 18.103 18.688	0.9615 0.9504 0.9472	0.0030 0.0030 0.0031	53.31 nm 54.09 nm 51.72 nm
Conversion Conversion	MoN MoN Mo ₂ N	15.944 18.103 18.688	0.9615 0.9504 0.9472	0.0147 0.0149 0.0151	10.47 nm 10.33 nm 10.19 nm

produce pores in the bulk of the structure, while remaining adhered to the substrate. As shown in Fig. 5a, the increase in deposition rate produced an increase in the surface area of the films. This is a direct result of the rapid reaction of MoCl₅ and NH₃. The surface area was also discovered to increase with the deposition temperature, as shown in Fig. 5b. This was due to the complete conversion of MoCl₅ to Mo_xN and subsequent production of pores in the film.

Molybdenum nitride electrodes were evaluated in 6.4M KOH electrolytes by AC impedance spectroscopy and cyclic voltammetry to determine their capacitance and electrochemical stability. In Fig. 6, the slope of the line in plots of frequency versus impedance is -1 which is typical of ideal porous electrodes displaying double layer capacitance. In Fig. 7, a cyclic voltammogram of a representative CVD Mo_xN electrode in the 6.4M KOH electrolyte is shown. The capacitance was determined to be 0.30 F/cm², which is less than Mo_xN electrodes prepared by conversion of MoO₃. However, the voltage stability of CVD Mo_xN electrodes is 0.9 volts which is 0.2 volts higher than Mo_xN electrodes prepared by the conversion of MoO₃.

IV. Conclusions

Mo_xN (MoN 60% and Mo₂N 40%) films void of large cracks on the surface have been deposited via CVD on polycrystalline titanium substrates. The EDX data shows a significant reduction in oxygen contamination in Mo_xN CVD films when compared to Mo_xN films prepared by the conversion of MoO₃. The average particle size of the CVD films was determined by Debye-Scherrer calculations to be ≈ 50 nm. The two phase Mo_xN films consisted of $\approx 60\%$ MoN and 40% γ -Mo₂N. AC Impedance and cyclic voltammetry data indicate that CVD Mo_xN films are capacitive with voltage stability of 0.9 volts in 6.4 M KOH electrolytes.

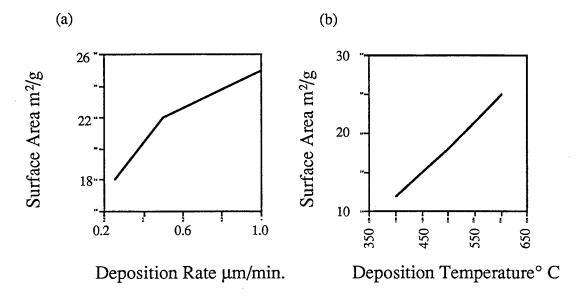


Figure 5. Plots of the surface area of CVD Mo_xN films versus (a) deposition rate at 600°C and (b) deposition temperature. The surface area was found to increase with both increasing deposition temperature and deposition rate.

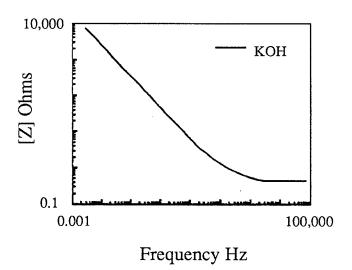


Figure 6. An AC impedance spectroscopy plot of frequency versus impedance. The slope of the line indicates a capacitive response of the electrode.

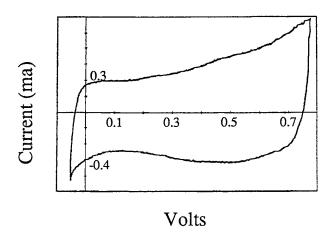


Figure 7. Cyclic voltammogram of CVD Mo_xN electrode in 6.4 M KOH.

V. References

- 1. S. L. Roberson, D. Finello and R. F. Davis, MRS Soc. Symp. Proc., Fall 1996, (to be published in Symp. P Proc.).
- 2. J. G. Choi, R. L. Curl and L. T. Thompson, Journal of Catalysis 146, 218 (1994).
- 3. R. S. Wise and E. J. Markel, Journal of Catalysis 145, 344 (1994).
- 4. L. Volpe and M. Boudart, Journal of Solid State Chemistry 59, 332 (1985).
- 5. C. H. Jaggers, J. M. Michaels and A. M. Stacy, Chemistry of Materials 2, 150 (1990).
- 6. S. L. Roberson, D. Finello and R. F. Davis, MRS Soc. Symp. Proc., Fall 1996, (to be published in Symp. V Proc.).

Distribution List

Dr. Alvin M. Goodman Office of Naval Research Electronics Division, Code: 312 Ballston Tower One 800 N. Quincy Street Arlington, VA 22217-5660	3
Administrative Contracting Officer Office of Naval Research Regional Office Atlanta 101 Marietta Tower, Suite 2805 101 Marietta Street Atlanta, GA 30323-0008	1
Director, Naval Research Laboratory ATTN: Code 2627 Washington, DC 20375	1
Defense Technical Information Center 8725 John J. Kingman Road, Suite 0944 Et Belvoir VA 22060-6218	2